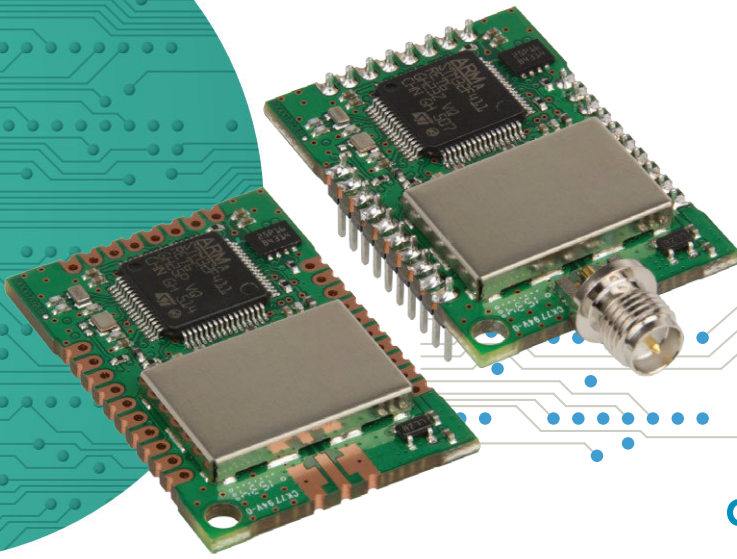


MultiTech mDot[™]

Long Range LoRa[®] Module



arm MBED



MultiTech mDot[™] is a secure, CE/FCC/RCM/GITEKI certified, Arm[®] Mbed[™] programmable, low-power RF module, that provides long-range, low bit rate M2M data connectivity to sensors, industrial equipment and remote appliances.

The mDot is LoRaWAN[®] 1.0.2 compliant, providing bi-directional data communication up to 10 miles / 15 km line-of-sight and 1-3 miles / 2 km into buildings**, using sub-GHz ISM bands in North America, Europe, Australia and Asia Pacific (AS923).

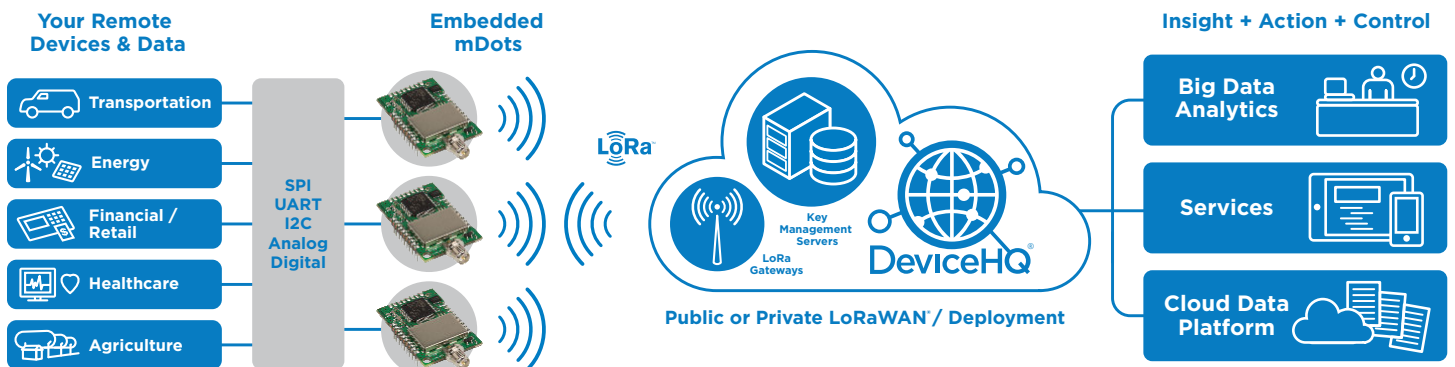
mDots bring intelligence, reduced complexity and a lower overall bill of material cost to the very edge of the network while supporting a variety of electronic interfaces to connect just about any “Thing” for years on battery power.

BENEFITS

- Range of miles
- Deep in-building penetration
- Developer friendly
- Runs for years on batteries

FEATURES

- FCC/CE/RCM/GITEKI certified for use in North America, Europe, Australia & Japan
- LoRaWAN Certified[™]
- Unicast & Multicast message support
- Multiple I/O interfaces for most any “Thing”
- Data rates 293 bps- 20 Kbps+ LoRa[®]



EDGE INTELLIGENCE

As the first Arm® Mbed™ Platform listed on mbed.org that is industry certified and deployment ready, applications can be written and compiled quickly online using developer friendly libraries, downloaded and hosted within the mDot. Decision making and control is distributed to the edge, enabling data to be more actionable without the heavy lift required to optimize RF performance, implement complex M2M middleware and security protocols needed to deploy a low touch install.

HIGHLIGHTS

Applications

- Manage and harvest sensor data
- Control and monitor remote assets and devices
- Mesh network replacement

Operating Modes

- LoRaWAN 1.0.2 compliant
- Developer friendly Arm Mbed libraries provides customization capability for specific applications
- Onboard flash and RAM reduces overall Build of Material costs

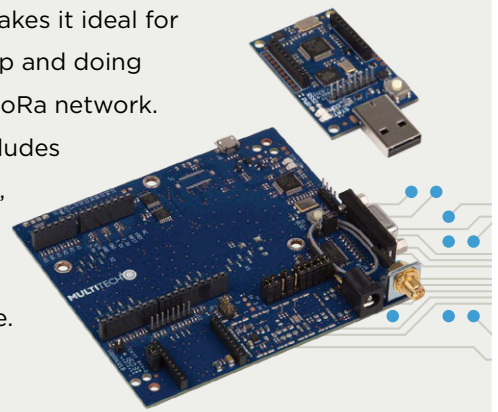
DEVELOPER KIT

The MultiTech mDot (MTUDK2-ST-MDOT) Developer Kit allows customers to plug in the MultiTech mDot module and use it for testing, programming and evaluation. This kit is designed for use with mDot long range, RF modules. This developer kit includes an antennas, USB cable, RSMA cable and Quick Start Guide.

The MultiTech mDot (MTMDK-ST-MDOT) Micro Developer Kit is a micro developer and programming board. This kit is available in the form of a USB dongle, allowing a developer to plug in a mDot or MultiTech mDot Box and start developing their own application.

Its portable design makes it ideal for connecting to a laptop and doing range testing of the LoRa network.

This developer kit includes a development board, LoRa antenna, programming cable and Quick Start Guide.

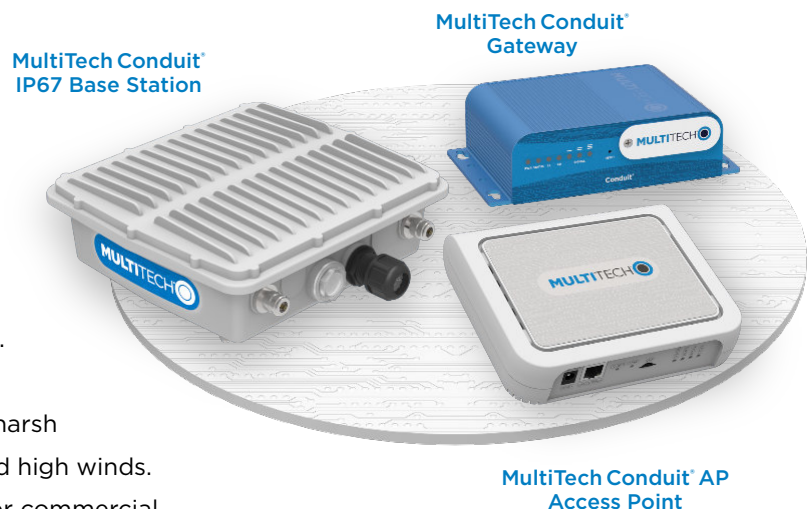


YOU MAY ALSO BE INTERESTED IN: MULTITECH CONDUIT® FAMILY

MultiTech Conduit® family of products is the industry's most configurable, manageable, and scalable cellular communications gateways for industrial IoT applications. Network engineers can remotely configure and optimize their Conduit performance through DeviceHQ®, the world's first IoT Application Store and Device Management platform.

The award-winning Conduit series comes in three variants designed to address specific IoT gateway use cases:

- **MultiTech Conduit:** Indoor industrial gateway, ideal for environments that require metal casing for protection against particles and debris and require an industrial temperature range.
- **MultiTech Conduit IP67 Base Station:** Outdoor IP67-rated gateway ideal suited for performing in harsh environments such as rain, snow, extreme heat, and high winds.
- **MultiTech Conduit AP:** Indoor access point ideal for commercial environments (e.g., hotels, offices, retail facilities) to deepen LoRa coverage in difficult to reach places where cell tower or rooftop deployments may not perform as well.



SPECIFICATIONS

Models	MTDOT-868	MTDOT-915	MTDOT-923
Region/Country	Europe	North America / Australia	Asia Pacific
Communication	LoRaWAN 1.0.2 compliant, Class A and Class C Arm Mbed libraries or AT commands for radio control		
Interfaces (pin functions are multiplexed)	Up to 21 Digital I/O, Up to 11 Analog Inputs, SPI, I2C, UART (RX, TX, RTS, CTS)		
Physical Dimensions	1.0" x 1.47" (25.5 X 37.3 mm)		
Radio Frequency			
Modulation	FSK, GFSK, MSK, GMSK, OOK, LoRa Digital Spread Spectrum		
Frequency	860-1020 MHz		
Performance			
CPU	STM32F411RET		
Max Clock	100 MHz (configurable to power use)		
Flash Memory	512 KB (400 KB customer usable)		
RAM	128 KB		
Power			
Max Transmitter Power Output (TPO)	14 dBm	19 dBm	Varies by Country
Max Receive Sensitivity	-137 dBm	-130 dBm	Varies by Country
Link Budget*	151 dB Point-to-Multipoint, 147 dB Point-to-Point	145 dB Point-to-Multipoint, 147 dB Point-to-Point	Varies by Country
* Calculation assumes two 0 dBi antennas. North America: Greaterlink budget possible with higher gain antennas. Europe: This is the maximum link budget. Note: Point-to-Multipoint utilizing MultiTech gateway with MTAC-LORA accessory card.			
Max Effective Isotropic Radiated Power (EIRP)	10 dBm	36 dBm	Varies by Country
Input Voltage	3.3 - 5VDC ±5%		
Environmental			
Operating Temperature	-40° C to +85° C (-40° F to +185° F)		
Storage Temperature	-40° C to +85° C (-40° F to +185° F)		
Relative Humidity	20% to 90% RH noncondensing		
Certifications			
EMC Compliance	US: FCC Part 15 Class B. EU: EN 55022 Class B, EN 55024. Canada: ICES-003		
Radio Compliance	FCC 15.247, IC RSS-210, EU EN 300 220		
Safety Compliance	UL/cUL 60950-1 2nd Ed., cUL 60950-1 2nd Ed., IEC 60950-1 2nd Ed., AS/NZS 60950.1		
Quality	MIL-STD-810G: High Temp, Low Temp, Random Vibration. SAE J1455: Transit Drop & Handling Drop, Random Vibration, Swept-Sine Vibration. IEC68-2-1: Cold Temp. IEC68-2-2: Dry Heat		

** Actual performance speeds may be affected by a variety of attributes such as distance from gateway, data loads, packet sizes, etc. Note: AS923 models are for use in many Asia Pacific countries. At this time regulatory approvals are pending. Contact your MultiTech sales representative for more information.

POWER DRAW

Voltage	3.3V		5.0V	
Sleep Mode (Version 0.1.2 or newer)	40.0µA			
Idle Current Average (Amps)	0.032			
Packet Size (Bytes)	10	53	19	53
Average Current (Amps) at Low Transmit Power Setting (TXP 2)	0.026			
Average Current (Amps) at Default Transmit Power Setting (TXP 11)	0.028	0.029	0.028	
Average Current (Amps) at Maximum Transmit Power Setting (TXP 20)	0.031	0.041	0.032	0.042
Total Inrush Charge Measured in Millicoulombs (mC)	1.14		1.79	
Total Inrush Charge Duration during Powerup (InRush Duration)	661µS		1.24mS	

ORDERING INFORMATION

MultiTech mDot™ European Models

Model	Description	Region
MTDOT-868-X1-SMA	868 MHz X1 LoRa SMA	Euro
MTDOT-868-X1P-SMA	868 MHz X1 LoRa SMA w/Programming Header	Euro
MTDOT-868-X1-UFL	868 MHz X1 LoRa UFL	Euro
MTDOT-868-M1-UFL	868 MHz SMT LoRa UFL	Euro
MTDOT-868-M1-TRC	868 MHz SMT LoRa RF Pad	Euro

MultiTech mDot™ North American Models

Model	Description	Region
MTDOT-915-X1-SMA	915 MHz X1 LoRa SMA	NAM
MTDOT-915-X1P-SMA	915 MHz X1 LoRa SMA w/Programming Header	NAM
MTDOT-915-X1-UFL	915 MHz X1 LoRa UFL	NAM
MTDOT-915-M1-UFL	915 MHz SMT LoRa UFL	NAM
MTDOT-915-M1-TRC	915 MHz SMT LoRa RF Pad	NAM

MultiTech mDot™ Australia/New Zealand Models

Model	Description	Region
MTDOT-915-AU-X1-SMA	AU915 MHz X1 LoRa SMA	AU/NZ
MTDOT-915-AU-X1P-SMA	AU915 MHz X1 LoRa SMA w/Programming Header	AU/NZ
MTDOT-915-AU-X1-UFL	AU915 MHz X1 LoRa UFL	AU/NZ
MTDOT-915-AU-M1-UFL	AU915 MHz SMT LoRa UFL	AU/NZ
MTDOT-915-AU-M1-TRC	AU915 MHz SMT LoRa RF Pad	AU/NZ

MultiTech mDot™ Asia Pacific Models

Model	Description	Region
MTDOT-923-AS1-X1P-SMA	AS923 MHz X1 LoRa SMA w/Programming Header	APAC
MTDOT-923-AS1-X1-UFL	AS923 MHz X1 LoRa UFL	APAC
MTDOT-923-AS1-M1-UFL	AS923 MHz SMT LoRa UFL	APAC
MTDOT-923-JP1-X1P-SMA	AS923 MHz X1 LoRa SMA w/Programming Header w/LBT	Japan

Note: All mDots listed above available in single, 50 or 100-pack depending on model

MultiTech mDot™ Developer Kits & Accessories

Model	Description	Region
MTUDK2-ST-MDOT	Developer Kit, includes SMA antenna & USB cable, (mDots sold separately)	Global
MTMDK-ST-MDOT	MultiTech mDot Micro Developer Kit (mDots sold separately)	Global
AN868-915A-1HRA	868-915 MHz RP-SMA Antenna, 8" (3.0dBi)	Global
CARSMA-UFL	Reverse SMA-to-UFL Coax RF Cable, 6"	Global

Go to www.multitech.com for detailed product model numbers.

The LoRa® name and associated logo are trademarks of Semtech Corporation or its subsidiaries.

Services & Warranty

MultiTech's comprehensive Support Services programs offer a full array of options to suit your specific needs. These services are aimed at protecting your investment, extending the life of your solution or product, and reducing total cost of ownership. Our seasoned technical experts, with an average tenure of more than 10 years, can walk you through smooth installations, troubleshoot issues and help you with configurations.

Installation Support

MultiTech's Installation Support Service delivers priority service with the ability to work one-on-one with an experienced MultiTech technical support engineer, to guide you through the installation process for our products.

Technical Support Services

At MultiTech, we're committed to providing you personalized attention and quality service while providing you a quick response to your product support needs. We have several options of support for you to choose from.

For additional information on Support Services as well as other service offerings, please contact your MultiTech representative or visit www.multitech.com/support.go

World Headquarters

Multi-Tech Systems, Inc.
2205 Woodale Drive
Mounds View, MN 55112 U.S.A.
Tel: 763-785-3500
Toll-Free: 800-328-9717
Email: sales@multitech.com
www.multitech.com

EMEA Headquarters

Multi-Tech Systems (EMEA)
Strata House
264-270 Bath Road
Harlington UB3 5JJ
United Kingdom
Tel: +(44) 118 959 7774
Email: sales@multitech.co.uk
www.multitech.co.uk

Produced in the U.S. of U.S. and non-U.S. components. Features and specifications are subject to change without notice.

Trademarks and Registered Trademarks: MultiTech and the MultiTech logo, mDot, Conduit: Multi-Tech Systems, Inc. All other products and technologies are the trademarks or registered trademarks of their respective holders.

2019-09 • 86002171-NMC • © 2019 Multi-Tech Systems, Inc. All rights reserved.

MULTITECH 

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [WiFi Modules - 802.11 category](#):

Click to view products by [Multitech manufacturer](#):

Other Similar products are found below :

[KBPC10/15/2506WP](#) [WIFI-RT5392-SB-R10](#) [SX-PCEAN2C-SP](#) [849WM520100E](#) [WIFI-AT2350](#) [7265.NGWG.SW](#) [HDG204-DN-3](#) [FXX-3061-MIX](#) [EMIO-1533-00A2](#) [PPC-WL-KIT02-R11](#) [RC-CC2640-B](#) [HLK-7688A](#) [E70-433T14S](#) [WH-NB73-BA](#) [NF-02-PA](#) [EAR00364](#) [3168.NGWG](#) [MY-WF003U](#) [AX210.NGWG.NV](#) [ESP-15F32Mbit](#) [ESP32-S32Mb](#) [TG-01M](#) [ESP-13](#) [ESP-01F-2M](#) [ESP-01E-2M](#) [ESP-12S-8285-2M](#) [ESP-20](#) [ESP32-SL](#) [ESP-12K-PSRAM](#) [ESP-12K](#) [ESP-12K-PSRAM-IPEX](#) [ESP-12H](#) [BW18](#) [BW12-16Mb](#) [BW14](#) [BW15](#) [BW16](#) [TG-12F](#) [SIM7600CE-L1S](#) [CB3S\(tjrl\)](#) [CB3S\(hvk9\)](#) [CB3S\(qh6\)](#) [WB2S\(csyd\)](#) [WB3S\(ppty\)](#) [WB3S\(h238\)](#) [WB3S\(uvmz\)](#) [1005869](#) [1012](#) [QCA4004X-BL3B](#) [32-2006-BU](#)